

Bipolar Transistor

(-)100 V, (-)2 A, Low V_{CE}(sat), (PNP) NPN Single PCP

2SA1417, 2SC3647

Features

- Adoption of FBET, MBIT Processes
- High Breakdown Voltage and Large Current Capacity
- Ultrasmall Size Making it Easy to Provide High-density Small-sized Hybrid ICs
- These Devices are Pb-Free and Halide Free

SPECIFICATIONS (): 2SA1417

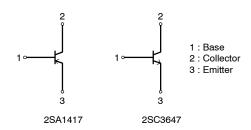
ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Symbol	Parameter	Conditions	Ratings	Unit
V _{CBO}	Collector-to-Base Voltage		(-)120	٧
V _{CEO}	Collector-to-Emitter Voltage		(-)100	V
V _{EBO}	Emitter-to- Base Voltage		(-)6	٧
I _C	Collector Current		(-)2	Α
I _{CP}	Collector Current (Pulse)		(-)3	Α
Pc	Collector Dissipation	When mounted on ceramic substrate	500	mW
	Dissipation	(250 mm ² x 0.8 mm)	1.5	W
Tj	Junction Temperature		150	°C
Tstg	Storage Temperature		– 55 to +150	°C

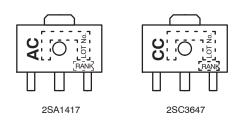
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



ELECTRICAL CONNECTION



MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping [†]
2SA1417S-TD-E	PCP (Pb-Free)	1000 / Tape & Reel
2SA1417T-TD-E	PCP (Pb-Free)	1000 / Tape & Reel
2SC3647S-TD-E	PCP (Pb-Free)	1000 / Tape & Reel
2SC3647T-TD-E	PCP (Pb-Free)	1000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.

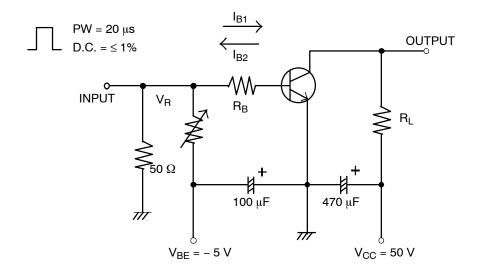
ELECTRICAL CHARACTERISTICS $(T_A = 25^{\circ}C)$

			Ratings			
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CBO}	Collector Cutoff Current	V _{CB} = (-)100 V, I _E = 0 A	-	-	(-)100	nA
I _{EBO}	Emitter Cutoff Current	V _{EB} = (-)4 V I _C = 0 A	-	-	(-)100	nA
h _{FE}	DC Current Gain	V _{CE} = (-)5 V, I _C = (-)100 mA	100*	-	400*	-
f _T	Gain-Bandwidth Product	V _{CE} = (-)10 V, I _C = (-)100 mA	-	120	-	MHz
Cob	Output Capacitance	V _{CB} = (-)10 V, f = 1 MHz	-	(25)16	-	pF
V _{CE} (sat)	Collector-to-Emitter Saturation Voltage	I _C = (-)1 A, I _B = (-)100 mA	-	(-0.22) 0.13	(-0.6) 0.4	V
V _{BE} (sat)	Base-to-Emitter Saturation Voltage	I _C = (-)1 A, I _B = (-)100 mA	-	(-)0.85	(-)1.2	V
V _{(BR)CBO}	Collector-to-Base Breakdown Voltage	$I_C = (-)10 \mu A, I_E = 0 A$	(-)120	-	-	V
V _{(BR)CEO}	Collector-to-Emitter Breakdown Voltage	I _C = (-)1 mA, R _{BE} = ∞	(-)100	-	-	V
V _{(BR)EBO}	Emitter-to-Base Breakdown Voltage	I _E = (-)10 μA, I _C = 0 A	(–)6	-	-	V
t _{on}	Turn-On Time	See specified Test Circuit.	-	(80)80	-	ns
t _{stg}	Storage Time		_	(750)1000	-	ns
t _f	Fall Time		_	(40)50	-	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. *The 2SA1417/2SC3647 are Classified by 100 mA h_{FE} as Follows:

Rank	R	s	Т
h _{FE}	100 to 200	140 to 280	200 to 400

SWITCHING TIME TEST CIRCUIT

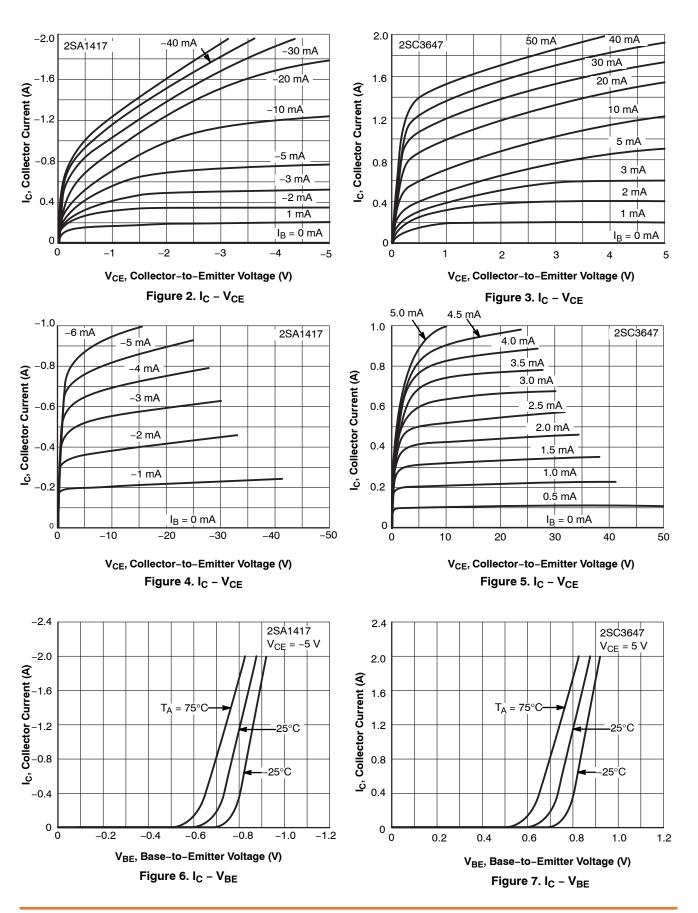


 I_C = 10 I_{B1} = -10 I_{B2} = 0.7 A For PNP, the polarity is reversed.

Figure 1. Switching Time Test Circuit

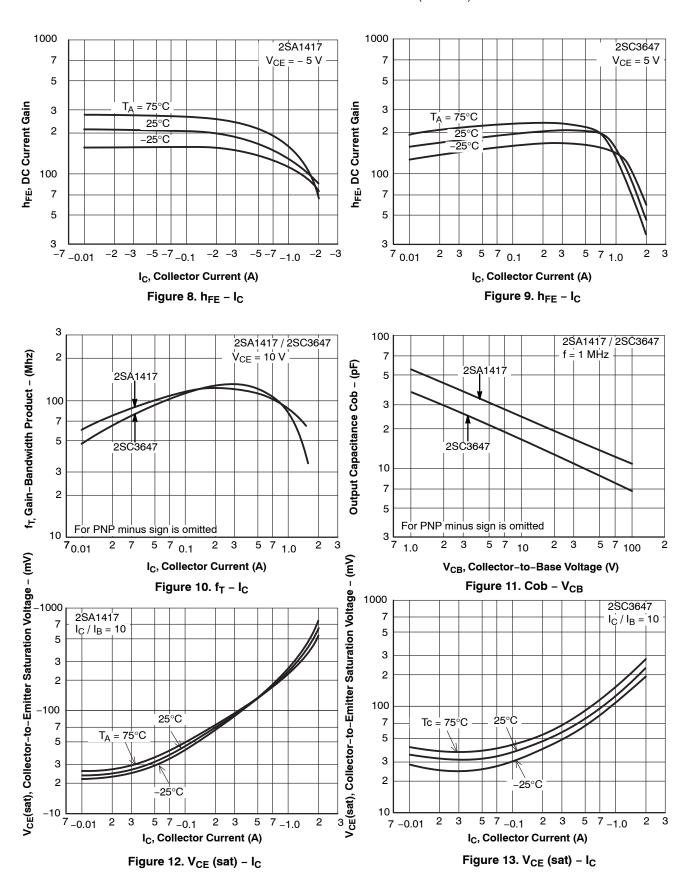
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TYPICAL CHARACTERISTICS



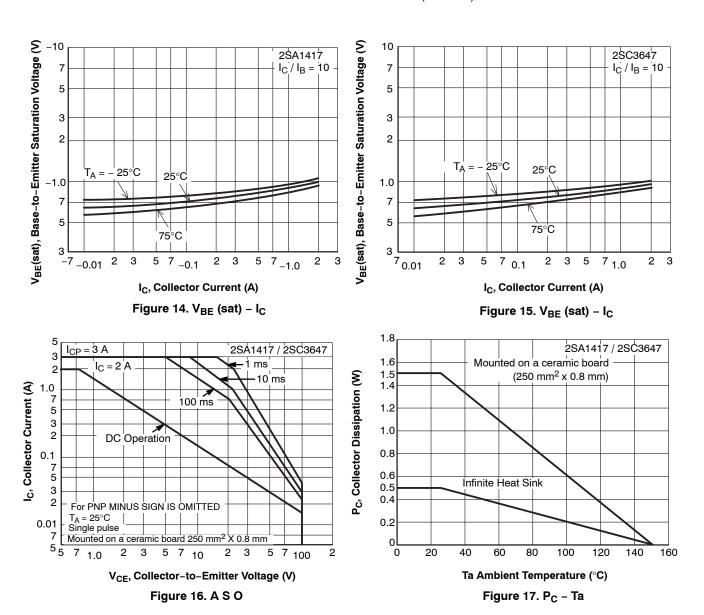
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TYPICAL CHARACTERISTICS (continued)



2SA1417, 2SC3647

TYPICAL CHARACTERISTICS (continued)







SOT-89 4.50x2.50x1.50 1.50P CASE 419AU **ISSUE A**

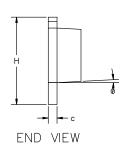
DATE 21 MAY 2025

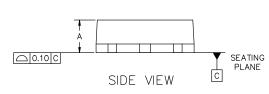
NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2018. CONTROLLING DIMENSION: MILLIMETERS. LEAD THICKNESS INCLUDES LEAD FINISH.

- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

MILLIMETERS				
DIM	MIN	NOM	MAX	
Α	1.40	1.50	1.60	
b	0.35	0.40	0.48	
b1	0.40	0.50	0.55	
С	0.37	0.40	0.43	
D	4.40	4.50	4.60	
D2	1.40	1.60	1.80	
E	2.40	2.50	2.60	
е	1.50 BSC			
Н	3.80	4.00	4.20	
L	0.80	1.00	1.20	
Θ	0.		3.	

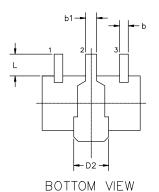


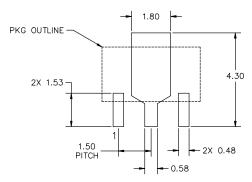


TOP VIEW

- A

В





RECOMMENDED MOUNTING FOOTPRINT

*For additional information on our Pb—Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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